

A mounting arrangement and a method for preventing a migration of soldering materials from an electric terminal into the body of an electric device via electric contacts that project from the body of the electric device. The mount comprises a platform that is adapted for spacing a base of the electric device from the electric terminal. The method comprises providing a surface of the electrical terminal with a depressed surface portion. The platform at least partially overlays the depressed surface portion and supports the body of the electric device such that the electric contacts project toward the depressed surface portion. Soldering materials are used to electrically connect the electric contact to the depressed surface portion.